

Example of typical operation switches installed in mobile devices (page 16)



## SPECIAL REPORT

### Mobile Communication Device

<b>Multifunctional Mobile Devices Steer Parts Market</b>	<b>10</b>
<b>TDK's SESUB Redesigns Modules in Mobile Devices</b>	<b>12</b>
<b>Murata Promotes SAW Bank for Advanced Phones</b>	<b>14</b>
<b>SMK Meets New Needs in Operation Switches</b>	<b>16</b>
<b>DNP's NFC Module Increases Design Freedom</b>	<b>19</b>

## TECHNOLOGY FOCUS

<b>Digital Power Control, Dimmer Function Define LED-Lighting LSI</b>	<b>23</b>
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## SMTs: IN REVIEW

<b>Panasonic Factory Solutions Rides on Manufacturing Optimism in China</b>	<b>26</b>
<b>Nippon Thompson Markets Tools for Chip, LC Production Machine</b>	<b>27</b>
<b>Topcon Develops High-Speed, High-Accuracy Bump Inspection System with 3D Sensor</b>	<b>27</b>

## TEST AND MEASUREMENTS

<b>Nihon Denkei Aims at Expanding Sales in Thailand</b>	<b>29</b>
<b>NF's New Tool Makes Way for Entry in Digital Multimeter Market</b>	<b>29</b>
<b>Anritsu Redefines Broadband VNA Market with Innovative VNA System</b>	<b>30</b>
<b>Anritsu Brings to Market High-Speed Interconnect Test Solution</b>	<b>31</b>

## SHOW PREVIEW

<b>TAITRONICS and Broadband Taiwan 2011</b>	
<b>Electronic Shows Highlight Taiwan's Technology Grit</b>	<b>32</b>
<b>NEPCON South China 2011</b>	
<b>LED to Add Value to SMT, Assembly at NEPCON South China</b>	<b>33</b>

## SHOW REPORT

<b>NEPCON Thailand 2011</b>	
<b>Manufacturing Expo Sets New Bar for Thai Event</b>	<b>34</b>

## CORPORATE CLOSE-UP

<b>Imagination Technologies Leverages on Diverse Products</b>	<b>36</b>
<b>Himax Technologies' 3D TCON Suits Mobile Devices</b>	<b>37</b>

## INDUSTRY REPORT

<b>Green Products Pave Way for Additional Sensor Demand</b>	<b>38</b>
<b>Navigation System Tracks Smartphones as Latest Platform</b>	<b>40</b>

## DEPARTMENTS

	AEI News	8
	Techwatch	9
	Business Strategy	35
	Product News	42

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